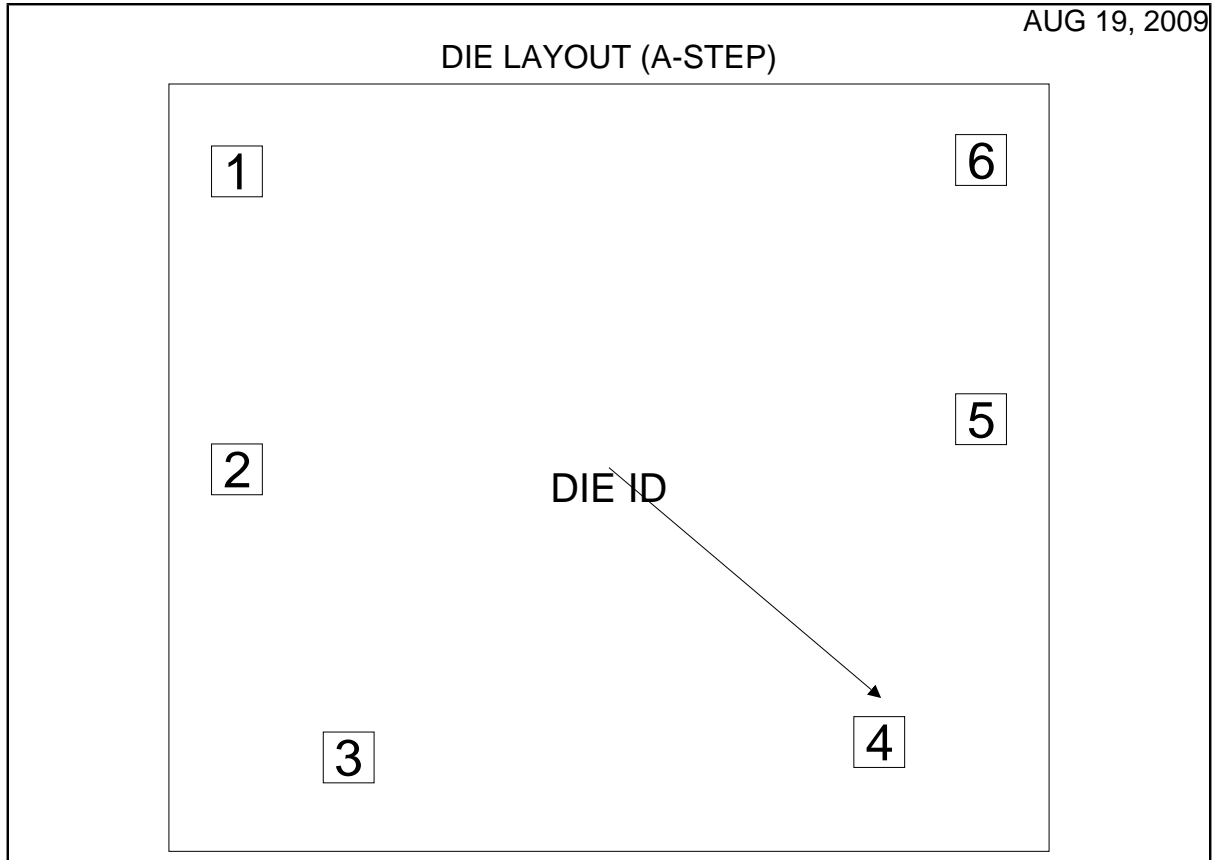


DAC121S101 MDR MCD3080A  
12-Bit Micro Power Digital-to-Analog Converter with Rail-to-Rail



**DIE/WAFER CHARACTERISTICS**

Fabrication Attributes		General Die Information	
Physical Die Identification	DAC121S101HR	Bond Pad Opening Size (min)	77.00µm x 77.00µm
Die Step	A	Bond Pad Metalization	AL 0.5%CU
Physical Attributes		Passivation	PECVDON NITRIDE
Wafer Diameter	200mm	Back Side Metal	Bare Back
Die Size (Drawn)	1333.50µm x 1163.32µm 52.5mils x 45.8mils	Back Side Connection	Floating or GND
Thickness	304.8µm Nominal		
Min Pitch	392.85µm		

Note: All values are rounded to the nearest micron.

Special Assembly Requirements:

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Die Bond Pad Coordinate Locations(A-Step)						
(Referenced to die center, coordinates in $\mu\text{m}$ ) NC = No Connection, N.U. = Not Used						
Signal Name	Pad Number	X/Y Coordinates		Pad Size		
		X	Y	X	Y	
	1	449	564	77	x	77
	2	-3	564	77	x	77
	3	-439	395	77	x	77
	4	-416	-410	77	x	77
	5	73	-564	77	x	77
	6	466	-564	77	x	77

**DAC121S101 MDR MCD3080A**  
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**Notes**

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